



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Ki-Won CHOI

Conf. No.

6747

Serial No.

10/055,266

Examiner:

Vu, Quang D

Filed:

January 22, 2002

Art Unit:

2811

For:

SEMICONDUCTOR PACKAGE HAVING CHANGED

SUBSTRATE DESIGN USING SPECIAL WIRE BONDING

Mail Stop NON FEE AMENDMENT Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Responsive to the Office Action dated February 13, 2004, enclosed is an amendment in the above-identified application.

The fee has been calculated as shown below.

CLAIMS AS AMENDED					
For:	Number After Amendment	Previous Number	Extra	Rate	Additional Fee
Total Claims	17	17	0	x \$18 =	\$0.00
Independent Claims	3	3	0	x \$86 =	\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

Exhibit A, 1 drawing sheet from U.S. Patent No. US 6,448,664 B1.

Any deficiency or overpayment should be charged or credited to deposit account number 13-1703.

Customer No. 20575

Respectfully submitted,

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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop Non Fee Amendment Commissioner for Patents, P.O. Box 1450, Alexandria, VA

22313-1450 Date: May 13.

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